Notice for TAIYO YUDEN Products

[For High Quality and/or Reliability Equipment (Automotive Electronic Equipment / Industrial Equipment)]

Please read this notice before using the TAIYO YUDEN products.

!\ REMINDERS

Product information in this catalog is as of October 2018. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

- Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available.
- Please conduct validation and verification of our products in actual condition of mounting and operating environment before using our products.
- The products listed in this catalog are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment), medical equipment classified as Class I or II by IMDRF, industrial equipment, and automotive interior applications, etc. Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment, medical equipment classified as Class III by IMDRF).

Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment*, medical equipment classified as Class IV by IMDRF, nuclear control equipment, undersea equipment, military equipment).

*Note: There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.

When our products are used even for high safety and/or reliability-required devices or circuits of general electronic equipment, it is strongly recommended to perform a thorough safety evaluation prior to use of our products and to install a protection circuit as necessary.

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

- Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.
- Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a fault or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement.
- The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.
- Caution for Export
 Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

Automotive Application Guide

We classify automotive electronic equipment into the following four application categories and set usable application categories for each of our products. When using our products for automotive electronic equipment, please be sure to check such application categories and use our products accordingly. Should you have any questions on this matter, please contact us.

| Category | Automotive Electronic Equipment (Typical Example) |
|----------------|--|
| | Engine ECU (Electronically Controlled Fuel Injector) |
| | Cruise Control Unit |
| | • 4WS (4 Wheel Steering) |
| POWERTRAIN | Automatic Transmission |
| | Power Steering |
| | HEV/PHV/EV Core Control (Battery, Inverter, DC-DC) |
| | Automotive Locator (Car location information providing device), etc. |
| | ABS (Anti-Lock Brake System) |
| SAFETY | • ESC (Electronic Stability Control) |
| SALLII | • Airbag |
| | ADAS (Equipment that directly controls running, turning and stopping), etc. |
| | • Wiper |
| | Automatic Door |
| | • Power Window |
| | Keyless Entry System |
| BODY & CHASSIS | • Electric Door Mirror |
| | • Interior Lighting |
| | • LED Headlight |
| | • TPMS (Tire Pressure Monitoring System) |
| | Anti-Theft Device (Immobilizer), etc. |
| | Car Infotainment System |
| INFOTAINMENT | • ITS/Telematics System |
| INFOTAINMENT | • Instrument Cluster |
| | • ADAS (Sensor, Equipment that is not interlocked with safety equipment or powertrain), etc. |

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MULTILAYER CERAMIC CAPACITORS





■PART NUMBER

| J | М | Κ | 3 | 1 | 6 | Δ | В | J | 1 | 0 | 6 | М | L | Н | Т | Δ |
|---|---|---|---|---|---|----------|---|---|---|---|---|---|---|----|----|----|
| 1 | 2 | 3 | | 4 | | ⑤ | | 6 | | 7 | | 8 | 9 | 10 | 11 | 12 |

△=Blank space

1 Rated voltage

| Code | Rated voltage[VDC] |
|------|--------------------|
| Α | 4 |
| J | 6.3 |
| L | 10 |
| E | 16 |
| Т | 25 |
| G | 35 |
| U | 50 |
| Н | 100 |
| Q | 250 |
| S | 630 |

| Code | End termination |
|------|---|
| K | Plated |
| J | Soft Termination |
| S | Cu Internal Electrodes (For High Frequency) |
| F | High Reliability Application |

| | Z/Series Hairie | |
|---|-----------------|---|
| ĺ | Code | Series name |
| | М | Multilayer ceramic capacitor |
| | V | Multilayer ceramic capacitor for high frequency |
| | W | LW reverse type multilayer capacitor |

(4)Dimension(L×W)

| | 4 Dimension (L X | · VV) | |
|--|------------------|----------------------|------------|
| | Туре | Dimensions (L×W)[mm] | EIA (inch) |
| | 063 | 0.6 × 0.3 | 0201 |
| | 105 | 1.0 × 0.5 | 0402 |
| | 105 | 0.52 × 1.0 ※ | 0204 |
| | 107 | 1.6 × 0.8 | 0603 |
| | | 0.8 × 1.6 🔆 | 0306 |
| | 010 | 2.0 × 1.25 | 0805 |
| | 212 | 1.25 × 2.0 💥 | 0508 |
| | 316 | 3.2 × 1.6 | 1206 |
| | 325 | 3.2 × 2.5 | 1210 |
| | 432 | 4.5 × 3.2 | 1812 |
| | | | |

Note: ※LW reverse type(□WK) only

5Dimension tolerance

| Code | Туре | L[mm] | W[mm] | T[mm] |
|------|------|-----------------|---------------------|-----------------|
| Δ | ALL | Standard | Standard | Standard |
| | 063 | 0.6±0.05 | 0.3±0.05 | 0.3±0.05 |
| | 105 | 1.0±0.10 | 0.5±0.10 | 0.5±0.10 |
| | 107 | 1.6+0.15/-0.05 | 0.8+0.15/-0.05 | 0.8+0.15/-0.05 |
| Α | 212 | 2.0+0.15/-0.05 | 1.25+0.15/-0.05 | 0.85±0.10 |
| | 212 | 2.0+0.15/ -0.05 | 1.25 + 0.15/ - 0.05 | 1.25+0.15/-0.05 |
| | 316 | 3.2±0.20 | 1.6±0.20 | 1.6±0.20 |
| | 325 | 3.2±0.30 | 2.5±0.30 | 2.5±0.30 |
| | 105 | 1.0+0.15/-0.05 | 0.5+0.15/-0.05 | 0.5+0.15/-0.05 |
| | 107 | 1.6+0.20/-0 | 0.8+0.20/-0 | 0.8+0.20/-0 |
| В | 212 | 2.0+0.20/-0 | 1.25+0.20/-0 | 0.85±0.10 |
| | | 2.0+0.20/ -0 | 1.25 + 0.20/ - 0 | 1.25+0.20/-0 |
| | 316 | 3.2±0.30 | 1.6±0.30 | 1.6±0.30 |
| | 105 | 1.0+0.20/-0 | 0.5+0.20/-0 | 0.5+0.20/-0 |
| С | 107 | 1.6+0.25/-0 | 0.8+0.25/-0 | 0.8+0.25/-0 |
| | 212 | 2.0+0.25/-0 | 1.25+0.25/-0 | 1.25+0.25/-0 |
| · | 212 | 2.0±0.15 | 1.25±0.15 | 0.85±0.15 |
| K | 316 | 3.2±0.20 | 1.6±0.20 | 1.15±0.20 |
| r. | 310 | 3.2 ± 0.20 | 1.0 ± 0.20 | 1.6±0.20 |
| | 325 | 3.2±0.50 | 2.5±0.30 | 2.5±0.30 |

Note: cf. STANDARD EXTERNAL DIMENSIONS

Δ= Blank space

6Temperature characteristics code

■ High dielectric type

| Code | Applicable | | | | Applicable standard | | Temperature range[°C] | Ref. Temp.[°C] | Capacitance change | Capacitance tolerance | Tolerance code | | | | | |
|------|--------------|----------|-------------------|---------|---------------------|---------|-----------------------|----------------|--------------------|--------------------------|-------------------|-----|------------|----|--------|------|
| | | | | 0.5 | 1.150/ | ±10% | K | | | | | | | | | |
| BJ | BJ EIA X5R | X5R | -55∼+ 85 | 25 | ±15% | ±20% | М | | | | | | | | | |
| C6 | C6 EIA X6S - | -55~+105 | 25 | ±22% | ±10% | K | | | | | | | | | | |
| | | 700 | 700 | 700 | 700 | 700 | 700 | 700 | 700 | 700 | 700 | 700 | 33 - 1 103 | 23 | = 22/0 | ±20% |
| В7 | EIA V7D | EIA V7 | ΕīΛ | EIA X7R | EIA V7D | EIA V7D | V7D | -55~+125 | 25 | ±15% | ±10% | K | | | | |
| | LIA | A/IN | 33.4 1 123 | 23 | ±1370 | ±20% | М | | | | | | | | | |
| C7 | EIA | X7S | -55~+125 | 25 | ±22% | ±10% | K | | | | | | | | | |
| | EIA | A/3 | -55° + 125 | 20 | ± 22% | ±20% | М | | | | | | | | | |
| D7 | EIA | X7T | -55 ~ +125 | 25 | +22%/-33% | ±10% | K | | | | | | | | | |
| | LIA | ^/1 | 33.3 T 123 | 20 | 1 22 70/ - 33 70 | ±20% | М | | | | | | | | | |

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■Temperature compensating type

| Code | | cable dard | Temperature range [°C] | Ref. Temp.[°C] | Capacitance change | Capacitance tolerance | Tolerance code |
|------|-----|---------------|------------------------|----------------|--------------------|--------------------------|-------------------|
| | | | | | | ±0.1pF | В |
| | JIS | CG | | 20 | | ±0.25pF | С |
| CG | | | -55 ~ +125 | | 0±30ppm/°C | ±0.5pF | D |
| CG | | | -55~+125 | | 0±30ppm/ C | ±1pF | F |
| | EIA | C0G | | 25 | | ±2% | G |
| | | | | | | ±5% | J |

7Nominal capacitance

| Code (example) | Nominal capacitance |
|-------------------|---------------------|
| 0R5 | 0.5pF |
| 010 | 1pF |
| 100 | 10pF |
| 101 | 100pF |
| 102 | 1,000pF |
| 103 | 0.01 <i>μ</i> F |
| 104 | 0.1 μ F |
| 105 | 1.0 <i>μ</i> F |
| 106 | 10 μ F |
| 107 | 100 μ F |

Note: R=Decimal point

8 Capacitance tolerance

| Code | Capacitance tolerance |
|------|-----------------------|
| Α | ±0.05pF |
| В | ±0.1pF |
| С | ±0.25pF |
| D | ±0.5pF |
| G | ±2% |
| J | ±5% |
| K | ±10% |
| М | ±20% |

Thickness

| Code | Thickness[mm] |
|------|-----------------------|
| Р | 0.3 |
| Т | 0.3 |
| V | 0.5 |
| С | 0.7(107type or more) |
| Α | 0.8 |
| D | 0.85(212type or more) |
| F | 1.15 |
| G | 1.25 |
| L | 1.6 |
| N | 1.9 |
| М | 2.5 |

®Special code

| Code | Special code |
|------|------------------------------------|
| Н | MLCC for Industrial and Automotive |

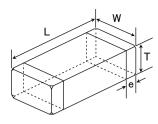
①Packaging

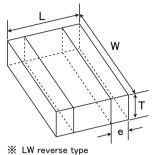
| Code | Packaging |
|------|--|
| F | ϕ 178mm Taping (2mm pitch) |
| R | ϕ 178mm Embossed Taping (4mm pitch) |
| Т | ϕ 178mm Taping (4mm pitch) |
| P | ϕ 178mm Taping (4mm pitch, 1000 pcs/reel) |
| Р | 325 type (Thickness code M) |

12Internal code

| Garresinar seas | |
|-----------------|---------------|
| Code | Internal code |
| Δ | Standard |

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| | | Dime | nsion [mm] (inch) | | |
|---------------|---------------------------------------|---|----------------------------|------------|--|
| Type(EIA) | L | W | T | *1 | е |
| | 0.6±0.03 | 0.3±0.03 | 0.3±0.03 | - | 0.15±0.05 |
| □MK063(0201) | (0.024 ± 0.001) | (0.012 ± 0.001) | (0.012±0.001) | Т | (0.006 ± 0.002) |
| □MK105(0402) | 1.0±0.05 | 0.5±0.05 | 0.5±0.05 | V | 0.25±0.10 |
| □MF105(0402) | (0.039 ± 0.002) | (0.020 ± 0.002) | (0.020 ± 0.002) | \ \ \ | (0.010 ± 0.004) |
| □WK105(0204)※ | 0.52 ± 0.05 | 1.0±0.05 | 0.3±0.05 | Р | 0.18±0.08 |
| | (0.020 ± 0.002) | (0.039 ± 0.002) | (0.012±0.002) | ļ <u>.</u> | (0.007±0.003) |
| □MK107(0603) | 1.6±0.10 | 0.8±0.10 | 0.8±0.10 | Α | 0.35±0.25 |
| □MF107(0603) | (0.063±0.004) | (0.031±0.004) | (0.031 ± 0.004) | - | (0.014±0.010) |
| □MJ107(0603) | 1.6±0.10 (0.063±0.004) | 0.8 ± 0.10 (0.031 \pm 0.004) | 0.8±0.10 (0.031±0.004) | Α | 0.35 + 0.3 / -0.25 (0.014 + 0.012 / -0.010) |
| | 1.6±0.10 | 0.031±0.004) | 0.031±0.004) | | 0.35 ± 0.25 |
| □VS107(0603) | (0.063 ± 0.004) | (0.031 ± 0.004) | (0.028 ± 0.004) | С | (0.014±0.010) |
| • | 0.8±0.10 | 1.6±0.10 | 0.5±0.05 | | 0.25±0.15 |
| □WK107(0306)※ | (0.031 ± 0.004) | (0.063 ± 0.004) | (0.020 ± 0.002) | ٧ | (0.010 ± 0.006) |
| | · · · · · · · · · · · · · · · · · · · | , | 0.85±0.10 | | , |
| □MK212(0805) | 2.0±0.10 | 1.25±0.10 | (0.033 ± 0.004) | D | 0.5±0.25 |
| □MF212(0805) | (0.079 ± 0.004) | (0.049 ± 0.004) | 1.25±0.10 | G | (0.020 ± 0.010) |
| | | | (0.049 ± 0.004) | G | |
| | | | 0.85±0.10 | D | |
| □MJ212(0805) | 2.0±0.10 | 1.25±0.10 | (0.033 ± 0.004) | | 0.5 + 0.35 / -0.25 |
| | (0.079 ± 0.004) | (0.049 ± 0.004) | 1.25±0.10 | G | (0.020 + 0.014 / -0.010) |
| | | | (0.049±0.004) | | |
| □VS212(0805) | 2.0±0.10 (0.079±0.004) | 1.25±0.10 (0.049±0.004) | 0.85±0.10 (0.033±0.004) | D | 0.5 ± 0.25 |
| • | 1.25±0.004) | 2.0±0.15 | 0.85±0.10 | | (0.020±0.010) 0.3±0.2 |
| □WK212(0508)※ | (0.049 ± 0.006) | (0.079±0.006) | (0.033 ± 0.004) | D | (0.012 ± 0.008) |
| • | (0.010 = 0.000) | (0.070 = 0.000) | 1.15±0.10 | | (0.012_0.000) |
| □MK316(1206) | 3.2±0.15 | 1.6±0.15 | (0.045 ± 0.004) | F | 0.5+0.35/-0.25 |
| □MF316(1206) | (0.126±0.006) | (0.063±0.006) | 1.6±0.20 | | (0.020 + 0.014 / -0.010) |
| | | | (0.063 ± 0.008) | L | |
| | | | 1.15±0.10 | | |
| | 3.2±0.15 | 1.6±0.15 | (0.045 ± 0.004) | F | 0.6 + 0.4 / -0.3 |
| □MJ316(1206) | (0.126 ± 0.006) | (0.063 ± 0.006) | 1.6±0.20 | | (0.024 + 0.016 / -0.012) |
| | | | (0.063 ± 0.008) | L | |
| | | | 1.15±0.10 | F | |
| | | | (0.045 ± 0.004) | <u>'</u> | |
| □MK325(1210) | 3.2±0.30 | 2.5±0.20 | 1.9±0.20 | N | 0.6±0.3 |
| □MF325(1210) | (0.126 ± 0.012) | (0.098 ± 0.008) | (0.075±0.008) | | (0.024 ± 0.012) |
| | | | 2.5±0.20 | М | |
| | | | (0.098±0.008) 1.9±0.20 | | |
| | 3.2±0.30 | 2.5±0.20 | (0.075 ± 0.008) | N | 0.6+0.4/-0.3 |
| □MJ325(1210) | (0.126±0.012) | (0.098 ± 0.008) | 2.5±0.20 | | (0.024 + 0.016 / -0.012) |
| | (<u>-</u> / | (====================================== | (0.098 ± 0.008) | М | |
| | 4.5±0.40 | 3.2±0.30 | 2.5±0.20 | ١., | 0.9±0.6 |
| □MK432(1812) | (0.177±0.016) | (0.126±0.012) | (0.098 ± 0.008) | М | (0.035 ± 0.024) |

(0.177±0.016) Note: X. LW reverse type, *1.Thickness code

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STANDARD QUANTITY

| Time | EIA (inch) | Dime | nsion | Standard quantity[pcs] | | |
|------|------------|------|-------|------------------------|--------------------|--|
| Type | EIA (Inch) | [mm] | Code | Paper tape | Embossed tape | |
| 063 | 0201 | 0.3 | Т | 15000 | _ | |
| 105 | 0402 | 0.5 | ٧ | 10000 | | |
| 105 | 0204 ※ | 0.30 | Р | 10000 | _ | |
| | | 0.7 | С | 4000 | _ | |
| | | 0.8 | Α | 4000 | | |
| | 0603 | 0.8 | Α | 3000 | _ | |
| 107 | 0003 | 0.0 | A | (Soft Termination) | _ | |
| | | 0.8 | Α | _ | 3000 | |
| | | 0.0 | Α | | (Soft Termination) | |
| | 0306 💥 | 0.50 | V | _ | 4000 | |
| | | 0.85 | D | 4000 | _ | |
| | 0805 | 1.25 | G | _ | 3000 | |
| 212 | 0000 | 1.25 | G | _ | 2000 | |
| | | 1.20 | g | _ | (Soft Termination) | |
| | 0508 ※ | 0.85 | D | 4000 | _ | |
| 316 | 1206 | 1.15 | F | _ | 3000 | |
| 310 | 1200 | 1.6 | L | _ | 2000 | |
| | | 1.15 | F | _ | 2000 | |
| 325 | 1210 | 1.9 | N |] - | 2000 | |
| | | 2.5 | М | _ | 500(T), 1000(P) | |
| 432 | 1812 | 2.5 | М | _ | 500 | |

Note: ※.LW Reverse type(□WK)

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Soft Termination Multilayer Ceramic Capacitors

●107TYPE (Dimension:1.6 × 0.8mm JIS:1608 EIA:0603)

[Temperature Characteristic B7 : $X7R(-55 \sim +125^{\circ}C)$] 0.8mm thickness(A)

| Part number 1 | Part number 2 | Rated voltage | Temperature | | Capacitance | Capacitance | tan δ | HTLT | *3.5.3 | Note |
|-------------------|---------------|---------------|-------------|----------|-------------|------------------|-------|-------------------|------------------|--------|
| Part number 1 | Part number 2 | [V] | charact | eristics | [F] | tolerance [%] | [%] | Rated voltage x % | Thickness*3 [mm] | Note |
| TMJ107BB7473[]AHT | | | | X7R | 0.047 μ | ±10, ±20 | 3.5 | 200 | 0.8+0.20/-0 | *1, *2 |
| TMJ107BB7104□AHT | | | | X7R | 0.1 μ | $\pm 10, \pm 20$ | 3.5 | 200 | 0.8+0.20/-0 | *1, *2 |
| TMJ107BB7224□AHT | | 25 | | X7R | 0.22 μ | ±10, ±20 | 10 | 150 | 0.8+0.20/-0 | *1, *2 |
| TMJ107BB7474[]AHT | | [| | X7R | 0.47 μ | ±10, ±20 | 10 | 150 | 0.8+0.20/-0 | *1, *2 |
| TMJ107CB7105∏AHR | | | | X7R | 1 μ | ±10, ±20 | 10 | 150 | 0.8+0.25/-0 | *1, *2 |
| GMJ107BB7473∏AHT | | | | X7R | 0.047 μ | ±10, ±20 | 3.5 | 200 | 0.8+0.20/-0 | *1, *2 |
| GMJ107BB7104□AHT | | | | X7R | 0.1 μ | ±10, ±20 | 3.5 | 200 | 0.8+0.20/-0 | *1, *2 |
| GMJ107BB7224□AHT | | 35 | | X7R | 0.22 μ | ±10, ±20 | 10 | 150 | 0.8+0.20/-0 | *1, *2 |
| GMJ107BB7474∏AHT | | | | X7R | 0.47 μ | ±10, ±20 | 10 | 150 | 0.8+0.20/-0 | *1, *2 |
| GMJ107CB7105[]AHR | | | | X7R | 1 μ | ±10, ±20 | 10 | 150 | 0.8+0.25/-0 | *1, *2 |
| UMJ107AB7102∏AHT | | | | X7R | 1000 p | ±10, ±20 | 3.5 | 200 | 0.8+0.15/-0.05 | *1, *2 |
| UMJ107AB7222∏AHT | | | | X7R | 2200 p | ±10, ±20 | 3.5 | 200 | 0.8+0.15/-0.05 | *1, *2 |
| UMJ107BB7472∏AHT | | | | X7R | 4700 p | ±10, ±20 | 3.5 | 200 | 0.8+0.20/-0 | *1, *2 |
| UMJ107BB7103[]AHT | | 50 | | X7R | 0.01 μ | ±10, ±20 | 3.5 | 200 | 0.8+0.20/-0 | *1, *2 |
| UMJ107BB7223[]AHT | | | | X7R | 0.022 μ | ±10, ±20 | 3.5 | 200 | 0.8+0.20/-0 | *1, *2 |
| UMJ107BB7473[]AHT | | | | X7R | 0.047 μ | ±10, ±20 | 3.5 | 200 | 0.8+0.20/-0 | *1, *2 |
| UMJ107BB7104[]AHT | | | | X7R | 0.1 μ | ±10, ±20 | 3.5 | 200 | 0.8+0.20/-0 | *1, *2 |
| HMJ107AB7102∏AHT | | | | X7R | 1000 p | ±10, ±20 | 3.5 | 200 | 0.8+0.15/-0.05 | *1, *2 |
| HMJ107AB7222[]AHT | | I | | X7R | 2200 p | ±10, ±20 | 3.5 | 200 | 0.8+0.15/-0.05 | *1, *2 |
| HMJ107BB7472[]AHT | | I | | X7R | 4700 p | ±10, ±20 | 3.5 | 200 | 0.8+0.20/-0 | *1, *2 |
| HMJ107BB7103[]AHT | | 100 | | X7R | 0.01 μ | ±10, ±20 | 3.5 | 200 | 0.8+0.20/-0 | *1, *2 |
| HMJ107BB7223[]AHT | | | | X7R | 0.022 μ | ±10, ±20 | 3.5 | 200 | 0.8+0.20/-0 | *1, *2 |
| HMJ107BB7473[]AHT | | | | X7R | 0.047 μ | ±10, ±20 | 3.5 | 200 | 0.8+0.20/-0 | *1, *2 |
| HMJ107BB7104[]AHT | | | | X7R | 0.1 μ | ±10, ±20 | 3.5 | 200 | 0.8+0.20/-0 | *1, *2 |

212TYPE (Dimension:2.0 × 1.25mm JIS:2012 EIA:0805)

[Temperature Characteristic B7: X7R(-55~+125°C). C7: X7S(-55~+125°C)] 0.85mm thickness(D), 1.25mm thickness(G)

| Li emperature Chara | CLERISTIC D7 . A/R(| 33.5 T 123 C | <i>5)</i> , 07. | X/3(- | 33.4 + 123 C/ | 0.65mm thickne | SS(D), 1. | ZJIIIII LIIICKIIESS | (u) | |
|---------------------|---------------------|---------------|-----------------|-----------|---------------|----------------|-------------|---------------------|------------------|--------|
| Part number 1 | Part number 2 | Rated voltage | Tempe | erature | Capacitance | Capacitance | $	an\delta$ | HTLT | Thickness*3 [mm] | Note |
| Fart Humber 1 | Fart number 2 | [V] | charact | teristics | [F] | tolerance [%] | [%] | Rated voltage x % | Inickness [mm] | Note |
| JMJ212CB7106∏GHT | | 6.3 | | X7R | 10 μ | ±10, ±20 | 10 | 150 | 1.25+0.25/-0 | *1, *2 |
| EMJ212CB7225∏GHT | | 16 | | X7R | 2.2 μ | ±10, ±20 | 10 | 150 | 1.25+0.25/-0 | *1, *2 |
| EMJ212CB7475∏GHT | | 10 | | X7R | 4.7 μ | ±10, ±20 | 10 | 150 | 1.25+0.25/-0 | *1, *2 |
| TMJ212CB7225[]GHT | | 25 | | X7R | 2.2 μ | ±10, ±20 | 10 | 150 | 1.25+0.25/-0 | *1, *2 |
| GMJ212CB7105[]GHT | | 35 | | X7R | 1 μ | ±10, ±20 | 10 | 150 | 1.25+0.25/-0 | *1, *2 |
| UMJ212BB7103[]GHT | | | | X7R | 0.01 μ | ±10, ±20 | 3.5 | 200 | 1.25+0.20/-0 | *1, *2 |
| UMJ212BB7223[]GHT | | | | X7R | 0.022 μ | ±10, ±20 | 3.5 | 200 | 1.25+0.20/-0 | *1, *2 |
| UMJ212BB7473[]GHT | | | | X7R | 0.047 μ | ±10, ±20 | 3.5 | 200 | 1.25+0.20/-0 | *1, *2 |
| UMJ212BB7104[]GHT | | 50 | | X7R | 0.1 μ | ±10, ±20 | 3.5 | 200 | 1.25+0.20/-0 | *1, *2 |
| UMJ212BB7224[]GHT | | | | X7R | 0.22 μ | ±10, ±20 | 3.5 | 200 | 1.25+0.20/-0 | *1, *2 |
| UMJ212CC7474[]GHTE | | | | X7S | 0.47 μ | ±10, ±20 | 3.5 | 150 | 1.25+0.25/-0 | *1, *2 |
| UMJ212CB7105 GHT | | | | X7R | 1 μ | ±10, ±20 | 10 | 150 | 1.25+0.25/-0 | *1, *2 |
| HMJ212KB7102□DHT | | | | X7R | 1000 p | ±10, ±20 | 3.5 | 200 | 0.85±0.15 | *1, *2 |
| HMJ212KB7222□DHT | | | | X7R | 2200 p | ±10, ±20 | 3.5 | 200 | 0.85 ± 0.15 | *1, *2 |
| HMJ212BB7472 GHT | | | | X7R | 4700 p | ±10, ±20 | 3.5 | 200 | 1.25+0.20/-0 | *1, *2 |
| HMJ212BB7103[]GHT | | | | X7R | 0.01 μ | ±10, ±20 | 3.5 | 200 | 1.25+0.20/-0 | *1, *2 |
| HMJ212BB7223 GHT | | 100 | | X7R | 0.022 μ | ±10, ±20 | 3.5 | 200 | 1.25+0.20/-0 | *1, *2 |
| HMJ212BB7473 GHT | | | | X7R | 0.047 μ | ±10, ±20 | 3.5 | 200 | 1.25+0.20/-0 | *1, *2 |
| HMJ212BB7104 GHT | | | | X7R | 0.1 μ | ±10, ±20 | 3.5 | 200 | 1.25+0.20/-0 | *1, *2 |
| HMJ212BB7224 GHT | | | | X7R | 0.22 μ | ±10, ±20 | 3.5 | 200 | 1.25+0.20/-0 | *1, *2 |
| HMJ212CC7474 GHTE | | | | X7S | 0.47 μ | ±10, ±20 | 3.5 | 150 | 1.25+0.25/-0 | *1, *2 |
| QMJ212KB7102 DHT | | | | X7R | 1000 p | ±10, ±20 | 2.5 | 150 | 0.85±0.15 | *1, *2 |
| QMJ212KB7222 DHT | | [| | X7R | 2200 p | ±10, ±20 | 2.5 | 150 | 0.85±0.15 | *1, *2 |
| QMJ212BB7472[]GHT | | 250 | | X7R | 4700 p | ±10, ±20 | 2.5 | 150 | 1.25+0.20/-0 | *1, *2 |
| QMJ212BB7103 GHT | | I l | | X7R | 0.01 μ | ±10, ±20 | 2.5 | 150 | 1.25+0.20/-0 | *1, *2 |
| QMJ212BB7223[]GHT | | | | X7R | 0.022 μ | ±10, ±20 | 2.5 | 150 | 1.25+0.20/-0 | *1, *2 |

[▶] This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (http://www.ty-top.com/).

316TYPE (Dimension:3.2 × 1.6mm JIS:3216 EIA:1206)

[Temperature Characteristic B7 : X7R($-55 \sim +125^{\circ}$ C), C7 : X7S($-55 \sim +125^{\circ}$ C)] 1.15mm thickness(F), 1.6mm thickness(L)

| Tremperature Onara | occuscio B7 : X7TC | 1 | 57, 07. | λ/ο\ | 33 1 123 C/1 | 1.10mm dilokite | ,33 (1 / , 1. | Ullilli tillekness (i | _/ | |
|-----------------------------|--------------------|----------------------|---------|----------------------|--------------------|---------------------------|----------------------|------------------------|------------------|------------------|
| Part number 1 | Part number 2 | Rated voltage [V] | | erature teristics | Capacitance [F] | Capacitance tolerance [%] | tan δ [%] | HTLT Rated voltage x % | Thickness*3 [mm] | Note |
| LMJ316BB7226∏LHT | | 10 | | X7R | 22 μ | ±10, ±20 | 10 | 150 | 1.6±0.30 | *1, *2 |
| EMJ316BB7475 LHT | | 10 | | X7R | 4.7 μ | ±10, ±20 | 10 | 150 | 1.6±0.30 | *1, *2 |
| EMJ316BB7106 LHT | | 16 | | X7R | 10 μ | ±10, ±20 | 10 | 150 | 1.6±0.30 | *1, *2 |
| TMJ316BB7474∏LHT | | | | X7R | 0.47 μ | ±10, ±20 | 3.5 | 200 | 1.6±0.30 | *1, *2 |
| TMJ316BB7475∏LHT | | 25 | | X7R | 4.7 μ | ±10, ±20 | 10 | 150 | 1.6±0.30 | *1, *2 |
| TMJ316BB7106 LHT | | - 23 | | X7R | 10 μ | ±10, ±20 | 10 | 150 | 1.6±0.30 | *1, *2 |
| GMJ316BB7474[]LHT | | | | X7R | 0.47 μ | ±10, ±20 | 3.5 | 200 | 1.6±0.30 | *1, *2 |
| GMJ316AB7225[]LHT | | + | | X7R | 2.2 μ | ±10, ±20 | 10 | 150 | 1.6±0.20 | *1, *2 |
| GMJ316BB7475[]LHT | | 35 | | X7R | 4.7 μ | ±10, ±20 | 10 | 150 | 1.6±0.20 | *1, *2 |
| GMJ316BB7106∏LHT | | + | | X7R | 10 μ | ±10, ±20 | 10 | 150 | 1.6±0.30 | *1, *2 |
| UMJ316BB7473∏LHT | | | | X7R | 0.047 μ | ±10, ±20 | 3.5 | 200 | 1.6±0.30 | *1, *2 |
| UMJ316BB7104[]LHT | | | | X7R | 0.047 μ | ±10, ±20 | 3.5 | 200 | 1.6±0.30 | *1, *2 |
| UMJ316BB7224\(\Display\)LHT | | | | X7R | , | ±10, ±20 | 3.5 | 200 | | |
| UMJ316BB7474\ LHT | | 50 | | X7R X7R | 0.22 μ 0.47 μ | ±10, ±20 ±10, ±20 | 3.5 | 200 | 1.6±0.30 | *1, *2 *1, *2 |
| | | 50 | | | | | | | 1.6±0.30 | |
| UMJ316BB7105 LHT | | 4 | | X7R | 1 μ | ±10, ±20 | 3.5 10 | 200 150 | 1.6±0.30 | *1, *2 |
| UMJ316AB7225[]LHT | | 4 | | X7R | 2.2 μ 4.7 μ | ±10, ±20 | 2.5 | 150 | 1.6±0.20 | *1, *2 |
| UMJ316BC7475[]LHTE | | | | X7S | | ±10, ±20 | | | 1.6±0.30 | *1, *2 |
| HMJ316 B7102 FHT | | 4 | | X7R | 1000 p | ±10, ±20 | 3.5 | 200 | 1.15±0.10 | *1, *2 |
| HMJ316 B7222 FHT | | 4 | | X7R | 2200 p | ±10, ±20 | 3.5 | 200 | 1.15±0.10 | *1, *2 |
| HMJ316 B7472 FHT | | 4 | | X7R | 4700 p | ±10, ±20 | 3.5 | 200 | 1.15±0.10 | *1, *2 |
| HMJ316KB7103 FHT | | 4 | | X7R | 0.01 μ | ±10, ±20 | 3.5 | 200 | 1.15±0.20 | *1, *2 |
| HMJ316BB7223 LHT | | 400 | | X7R | 0.022 μ | ±10, ±20 | 3.5 | 200 | 1.6±0.30 | *1, *2 |
| HMJ316BB7473 LHT | | 100 | | X7R | 0.047 μ | ±10, ±20 | 3.5 | 200 | 1.6±0.30 | *1, *2 |
| HMJ316BB7104[]LHT | | <u> </u> | | X7R | 0.1 μ | ±10, ±20 | 3.5 | 200 | 1.6±0.30 | *1, *2 |
| HMJ316BB7224[LHT | | <u> </u> | | X7R | 0.22 μ | ±10, ±20 | 3.5 | 200 | 1.6±0.30 | *1, *2 |
| HMJ316BB7474[]LHT | | <u> </u> | | X7R | 0.47 μ | ±10, ±20 | 3.5 | 200 | 1.6±0.30 | *1, *2 |
| HMJ316BB7105[LHT | | <u> </u> | | X7R | 1 μ | ±10, ±20 | 3.5 | 200 | 1.6±0.30 | *1, *2 |
| HMJ316BC7225[]LHTE | | | | X7S | 2.2 μ | ±10, ±20 | 3.5 | 150 | 1.6±0.30 | *1, *2 |
| QMJ316 B7102[FHT | | <u> </u> | | X7R | 1000 p | ±10, ±20 | 2.5 | 150 | 1.15±0.10 | *1, *2 |
| QMJ316 B7222[]FHT | | <u> </u> | | X7R | 2200 p | ±10, ±20 | 2.5 | 150 | 1.15±0.10 | *1, *2 |
| QMJ316 B7472[FHT | | 1 | | X7R | 4700 p | ±10, ±20 | 2.5 | 150 | 1.15±0.10 | *1, *2 |
| QMJ316KB7103[FHT | | 250 | | X7R | 0.01 μ | ±10, ±20 | 2.5 | 150 | 1.15±0.20 | *1, *2 |
| QMJ316BB7223[LHT | | 1 | | X7R | 0.022 μ | ±10, ±20 | 2.5 | 150 | 1.6±0.30 | *1, *2 |
| QMJ316BB7473[LHT | |] | | X7R | 0.047 μ | ±10, ±20 | 2.5 | 150 | 1.6±0.30 | *1, *2 |
| QMJ316BB7104[LHT | | | | X7R | 0.1 μ | ±10, ±20 | 2.5 | 150 | 1.6±0.30 | *1, *2 |
| SMJ316 B7102[]FHT | | 1 | | X7R | 1000 p | ±10, ±20 | 2.5 | 120 | 1.15±0.10 | *1, *2 |
| SMJ316 B7222[]FHT | | 1 | | X7R | 2200 p | ±10, ±20 | 2.5 | 120 | 1.15±0.10 | *1, *2 |
| SMJ316 B7472[]FHT | | 630 | | X7R | 4700 p | ±10, ±20 | 2.5 | 120 | 1.15±0.10 | *1, *2 |
| SMJ316KB7103[FHT | | 1 | | X7R | 0.01 μ | ±10, ±20 | 2.5 | 120 | 1.15±0.20 | *1, *2 |
| SMJ316BB7223 LHT | | | | X7R | 0.022 μ | ±10, ±20 | 2.5 | 120 | 1.6±0.30 | *1, *2 |

325TYPE (Dimension:3.2 × 2.5mm JIS:3225 EIA:1210)

[Temperature Characteristic B7 : X7R($-55 \sim +125^{\circ}$ C), C7 : X7S($-55 \sim +125^{\circ}$ C)] 1.9mm thickness(N), 2.5mm thickness(M)

| Part number 1 | Part number 2 | Rated voltage | Tempe | erature | Capacitance | Capacitance | $	an\delta$ | HTLT | Thickness*3 [mm] | Note |
|-------------------|---------------|---------------|---------|----------|-------------|---------------|-------------|-------------------|------------------|--------|
| Part number 1 | Part number 2 | [V] | charact | eristics | [F] | tolerance [%] | [%] | Rated voltage x % | Thickness [mm] | Note |
| JMJ325KB7476[]MHP | | 6.3 | | X7R | 47 μ | ±10, ±20 | 10 | 150 | 2.5±0.30 | *1, *2 |
| EMJ325KB7226[]MHP | | 16 | | X7R | 22 μ | ±10, ±20 | 10 | 150 | 2.5 ± 0.30 | *1, *2 |
| TMJ325AB7475∏MHP | | 25 | | X7R | 4.7 μ | ±10, ±20 | 5 | 150 | 2.5±0.30 | *1, *2 |
| TMJ325KB7106[]MHP | | 23 | | X7R | 10 μ | ±10, ±20 | 10 | 150 | 2.5±0.30 | *1, *2 |
| GMJ325AB7475 MHP | | 35 | | X7R | 4.7 μ | ±10, ±20 | 5 | 150 | 2.5±0.30 | *1, *2 |
| GMJ325KB7106□MHP | | 33 | | X7R | 10 μ | ±10, ±20 | 10 | 150 | 2.5 ± 0.30 | *1, *2 |
| UMJ325AB7225□MHP | | | | X7R | 2.2 μ | ±10, ±20 | 3.5 | 200 | 2.5 ± 0.30 | *1, *2 |
| UMJ325AB7475□MHP | | 50 | | X7R | 4.7 μ | ±10, ±20 | 5 | 150 | 2.5±0.30 | *1, *2 |
| UMJ325KB7106□MHP | | | | X7R | 10 μ | ±10, ±20 | 10 | 150 | 2.5 ± 0.30 | *1, *2 |
| HMJ325 B7223□NHT | | | | X7R | 0.022 μ | ±10, ±20 | 3.5 | 200 | 1.9±0.20 | *1, *2 |
| HMJ325 B7473□NHT | | | | X7R | 0.047 μ | ±10, ±20 | 3.5 | 200 | 1.9±0.20 | *1, *2 |
| HMJ325 B7104□NHT | | | | X7R | 0.1 μ | ±10, ±20 | 3.5 | 200 | 1.9±0.20 | *1, *2 |
| HMJ325 B7224□NHT | | 100 | | X7R | 0.22 μ | ±10, ±20 | 3.5 | 200 | 1.9±0.20 | *1, *2 |
| HMJ325 B7474□NHT | | | | X7R | 0.47 μ | ±10, ±20 | 3.5 | 200 | 1.9±0.20 | *1, *2 |
| HMJ325 B7105□NHT | | | | X7R | 1 μ | ±10, ±20 | 3.5 | 200 | 1.9±0.20 | *1, *2 |
| HMJ325AB7225□MHP | | | | X7R | 2.2 μ | ±10, ±20 | 3.5 | 200 | 2.5±0.30 | *1, *2 |
| HMJ325KC7475□MHPE | | | | X7S | 4.7 μ | ±10, ±20 | 3.5 | 150 | 2.5 ± 0.30 | *1, *2 |
| QMJ325 B7223[NHT | | | | X7R | 0.022 μ | ±10, ±20 | 2.5 | 150 | 1.9±0.20 | *1, *2 |
| QMJ325 B7473[NHT | | 250 | | X7R | 0.047 μ | ±10, ±20 | 2.5 | 150 | 1.9±0.20 | *1, *2 |
| QMJ325 B7104[NHT | | 230 | | X7R | 0.1 μ | ±10, ±20 | 2.5 | 150 | 1.9±0.20 | *1, *2 |
| QMJ325 B7224[NHT | | | | X7R | 0.22 μ | ±10, ±20 | 2.5 | 150 | 1.9±0.20 | *1, *2 |
| SMJ325 B7223[]NHT | | 630 | | X7R | 0.022 μ | ±10, ±20 | 2.5 | 120 | 1.9±0.20 | *1, *2 |
| SMJ325 B7473∏NHT | | 000 | | X7R | 0.047 μ | ±10, ±20 | 2.5 | 120 | 1.9±0.20 | *1, *2 |

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Multilayer Ceramic Capacitors

■PACKAGING

1)Minimum Quantity

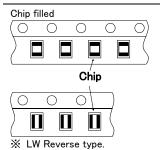
| Taped package | | | | | | |
|----------------------|---------|------|------------|-------------------------|--|--|
| Type(EIA) | Thick | ness | Standard o | Standard quantity [pcs] | | |
| Type(LIA) | mm | code | Paper tape | Embossed tape | | |
| ☐MK021(008004) | 0.125 | K | _ | 50000 | | |
| □VS021(008004) | 0.123 | IX . | | 30000 | | |
| ☐MK042(01005) | 0.2 | C, D | _ | 40000 | | |
| □VS042(01005) | 0.2 | С | | 40000 | | |
| □MK063(0201) | 0.3 | P,T | 15000 | _ | | |
| □WK105(0204) ※ | 0.3 | Р | 10000 | _ | | |
| | 0.13 | Н | _ | 20000 | | |
| | 0.18 | E | _ | 15000 | | |
| ☐MK105(0402) | 0.2 | С | 20000 | _ | | |
| □MF105(0402) | 0.3 | Р | 15000 | _ | | |
| | 0.5 | V | 10000 | _ | | |
| □VK105(0402) | 0.5 | W | 10000 | _ | | |
| □MK107(0603) | 0.45 | K | 4000 | _ | | |
| □WK107(0306) ※ | 0.5 | V | _ | 4000 | | |
| □MF107(0603) | 0.8 | Α | 4000 | _ | | |
| □VS107(0603) | 0.7 | С | 4000 | _ | | |
| □MJ107(0603) | 0.8 | Α | 3000 | 3000 | | |
| □MK212(0805) | 0.45 | K | 4000 | | | |
| □WK212(0508) ※ | 0.85 | D | 4000 | _ | | |
| □MF212(0805) | 1.25 | G | _ | 3000 | | |
| □VS212(0805) | 0.85 | D | 4000 | _ | | |
| | 0.85 | D | 4000 | _ | | |
| □MJ212(0805) | 1.25 | G | _ | 2000 | | |
| | 0.85 | D | 4000 | _ | | |
| ☐MK316(1206) | 1.15 | F | _ | 3000 | | |
| □MF316(1206) | 1.6 | L | _ | 2000 | | |
| | 1.15 | F | _ | 3000 | | |
| □MJ316(1206) | 1.6 | L | _ | 2000 | | |
| | 0.85 | D | | | | |
| | 1.15 | F | | | | |
| □MK325(1210) | 1.9 | N | | 2000 | | |
| □MF325(1210) | 2.0max. | Υ | 7 | | | |
| | 2.5 | М | _ | 1000 | | |
| DM 1005(1010) | 1.9 | N | _ | 2000 | | |
| □MJ325(1210) | 2.5 | М | _ | 500(T), 1000(P) | | |
| □MK432(1812) | 2.5 | М | _ | 500 | | |

Note:

K LW Reverse type.

**No bottom tape for pressed carrier tape Card board carrier tape Top tape Base tape Sprocket hole Chip cavity Base tape Chip cavity

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3 Representative taping dimensions

 (0.079 ± 0.002)

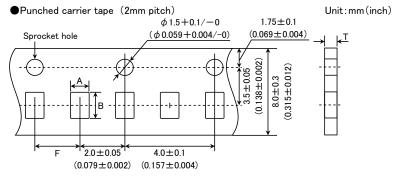
Paper Tape (8mm wide) Pressed carrier tape (2mm pitch) Unit:mm(inch) Sprocket hole $(\phi 0.059 + 0.004/-0)$ (0.069 ± 0.004) (0.069

| Type(EIA) | Chip | Cavity | Insertion Pitch | Tape Thickness | | |
|---------------------|------|--------|-----------------|----------------|----------|---------|
| Type(EIA) | Α | В | F | Т | T1 | |
| ☐MK063(0201) | 0.37 | 0.67 | | 0.45max. | 0.42max. | |
| □WK105(0204) ※ | | | 204005 | 0.45max. | 0.42max. | |
| ☐MK105(0402) (*1 C) | 0.65 | 1.15 | 1.15 | 2.0±0.05 | 0.4max. | 0.3max. |
| □MK105(0402) (*1 P) | | | | 0.45max. | 0.42max. | |

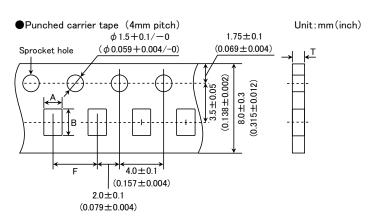
Note *1 Thickness, C:0.2mm ,P:0.3mm. * LW Reverse type.

 (0.157 ± 0.004)

Unit:mm



| Type(EIA) | Chip (| Cavity | Insertion Pitch | Tape Thickness |
|---------------|--------|--------|-----------------|----------------|
| Type(EIA) | Α | В | F | Т |
| ☐MK105 (0402) | | | | |
| ☐MF105 (0402) | 0.65 | 1.15 | 2.0 ± 0.05 | 0.8max. |
| □VK105 (0402) | | | | |
| | | | | Unit:mm |



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| Type(EIA) | Chip (| Cavity | Insertion Pitch | Tape Thickness |
|----------------|--------|--------|-----------------|----------------|
| Type(EIA) | Α | В | F | Т |
| ☐MK107(0603) | | | | |
| □WK107(0306) ※ | 1.0 | 1.8 | | 1.1max. |
| ☐MF107(0603) | | | 40+01 | |
| ☐MK212(0805) | 1.65 | 0.4 | 4.0±0.1 | |
| □WK212(0508) ※ | 1.65 | 2.4 | | 1.1max. |
| ☐MK316(1206) | 2.0 | 3.6 | | |

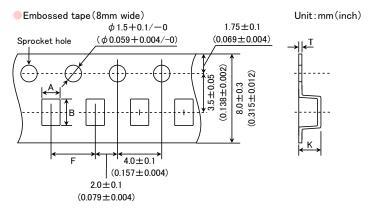
Note: Taping size might be different depending on the size of the product. X LW Reverse type.

Unit:mm

| Embossed tape (4mm wide) | | | Unit:mm(inch) |
|--------------------------|--------------------------|--|--|
| | ϕ 0.8 ± 0.04 | 0.9±0.05 | |
| Sprocket hole | $(\phi 0.031 \pm 0.002)$ | (0.035 ± 0.002) | → < ^T |
| • | 2.0±0.04 079±0.002) | $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | K K |

| Type(EIA) | Chip Cavity Insertion Pitch | | Insertion Pitch | Tape Thickness | | |
|----------------|-----------------------------|------|-----------------|----------------|----------|--|
| Type(EIA) | Α | В | F | K | Т | |
| ☐MK021(008004) | 0.135 | 0.27 | | | | |
| □VS021(008004) | 0.135 | 0.27 | 101000 | 0.5 | 0.25max. | |
| ☐MK042(01005) | 0.23 | 0.40 | 1.0±0.02 | 0.5max. | | |
| □VS042(01005) | 0.23 | 0.43 | | | | |

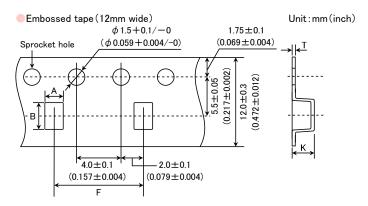
Unit:mm



| Type(EIA) | Chip (| Chip Cavity Insertion Pitc | | Tape Ti | nickness |
|------------------------------|--------|----------------------------|---------|---------|----------|
| Type(EIA) | Α | В | F | K | Т |
| ☐MK105(0402) | 0.6 | 1.1 | 2.0±0.1 | 0.6max | 0.2±0.1 |
| □WK107(0306) ※ | 1.0 | 1.8 | | 1.3max. | 0.25±0.1 |
| ☐MK212(0805) ☐MF212(0805) | 1.65 | 2.4 | | | |
| □MK316(1206) □MF316(1206) | 2.0 | 3.6 | 4.0±0.1 | 3.4max. | 0.6max. |
| □MK325(1210) □MF325(1210) | 2.8 | 3.6 | | | |

Note: ※ LW Reverse type.

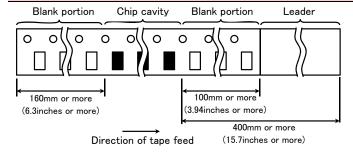
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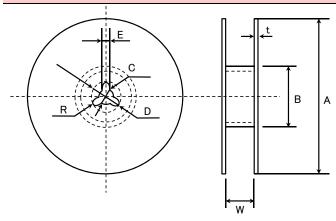
| Type(EIA) | Chip Cavity | | Insertion Pitch | Tape Th | nickness |
|--------------|-------------|-----|-----------------|---------|----------|
| Type(EIA) | Α | В | F | K | Т |
| ☐MK325(1210) | 3.1 | 4.0 | 8.0±0.1 | 4.0max. | 0.6max. |
| ☐MK432(1812) | 3.7 | 4.9 | 8.0±0.1 | 4.0max. | 0.6max. |

Unit:mm

4 Trailer and Leader



⑤Reel size



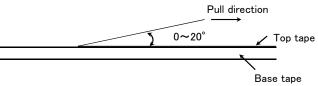
| Α | В | С | D | E | R |
|------------------|-----------------|-----------------------|-------------------|---------|-----|
| ϕ 178 ± 2.0 | <i>ф</i> 50min. | ϕ 13.0 \pm 0.2 | ϕ 21.0 ± 0.8 | 2.0±0.5 | 1.0 |

| | T | W |
|----------------|---------|--------|
| 4mm wide tape | 1.5max. | 5±1.0 |
| 8mm wide tape | 2.5max. | 10±1.5 |
| 12mm wide tape | 2.5max. | 14±1.5 |

Unit:mm

®Top Tape Strength

The top tape requires a peel-off force of 0.1 to 0.7N in the direction of the arrow as illustrated below.



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Multilayer Ceramic Capacitors

■RELIABILITY DATA

| 1.Operating T | emperature Range | | | | | | |
|---|---|----------------------------------|--------------------|---|--------------------------------|---------|--|
| 1.oporating 1 | Temperature | Standard | | | | | |
| | Compensating (Class1) | High Frequency Type | −55 to + | -125℃ | | | |
| | | | | | | | |
| | | | | Specification | Temperature Range | | |
| | | | | В | -25 to +85°C | | |
| Specified | | | BJ | X5R | _55 to +85°C | | |
| Value | | | В7 | X7R | −55 to +125°C | | |
| value | High Permittivity (Class2) |) | C6 | X6S | −55 to +105°C | | |
| | | | C7 | X7S | −55 to +125°C | | |
| | | | D7 | X7T | -55 to +125°C | | |
| | | | LD(※) | X5R | −55 to +85°C | | |
| . Storage Co | nditions | | | | gh value multilayer ceramic ca | | |
| | | Standard | | | | | |
| | Temperature Compensating(Class1) | High Frequency Type | −55 to + | -125°C | | | |
| | | | | Specification | Temperature Range | | |
| | | | D.I. | В | −25 to +85°C | | |
| Specified | | | BJ | X5R | −55 to +85°C | | |
| Value | | | B7 | X7R | −55 to +125°C | | |
| | High Permittivity (Class2) |) | C6 | X6S | −55 to +105°C | | |
| | | | C7 | X7S | −55 to +125°C | | |
| | | | D7 | X7T | -55 to +125°C | | |
| | | | LD(※) | X5R | −55 to +85°C | | |
| | | | Note: 🔆 | LD Low distortion hi | gh value multilayer ceramic ca | pacitor | |
| 3. Rated Volta | age | | | | | | |
| | Temperature | Standard | 50VDC, 25 | VDC | | | |
| Specified Value | Compensating(Class1) | High Frequency Type | 50VDC, 25VDC | | | | |
| v alu c | High Permittivity (Class2) | | 50VDC, 35 | 50VDC, 35VDC, 25VDC, 16VDC, 10VDC, 6.3VDC, 4VDC, 2.5VDC | | | |
| | | | | | | | |
| | | | | | | | |
| 4. Withstandir | ng Voltage(Between terminal | s) | 1 | | | | |
| | g Voltage (Between terminal | s) Standard | | | | | |
| Specified | | Standard | No breakdo | own or damage | | | |
| Specified | Temperature | Standard High Frequency Type | No breakdo | own or damage | | | |
| Specified Value | Temperature Compensating(Class1) | Standard High Frequency Type | No breakdo | | ass 2 | | |
| Specified Value Test | Temperature Compensating(Class1) | Standard High Frequency Type Cla | | CI | ass 2 oltage × 2.5 | | |
| 4. Withstandir Specified Value Test Methods and Remarks | Temperature Compensating(Class1) High Permittivity (Class2) | Standard High Frequency Type Cla | ass 1 volta × 3 | CI | | | |

Standard

High Frequency Type

: Rated voltage

: 60±5 sec.

: 50mA max.

Temperature

Applied voltage

Duration

Specified Value

Methods and

Remarks

Test

 ${\sf Compensating}({\sf Class1})$

Charge/discharge current

High Permittivity (Class2) Note 1

10000 $M\,\Omega$ min.

C \leq 0.047 μ F : 10000 M Ω min.

C>0.047 μ F : 500M Ω • μ F

| 6. Capacitance | (Tolerance) | | | | | | |
|------------------------|---------------------------------------|---------------------|---|---------------------------------------|--|-------------------------|--|
| | Temperature Compensating(Class1) High | Standard | C □ U □ SL | 0.2pF≦C≦5pF 0.2pF≦C≦10pF C>10pF | : ±0.25pF : ±0.5pF : ±5% or ±10% | | |
| Specified Value | | High Frequency Type | СН | 0.3pF≦C≦2pF C>2pF | : ±0.1pF : ±5% | | |
| | High Permittivity (Class2) | | BJ, B7, C6, C7, D7, LD(※): ±10% or ±20% Note: ※LD Low distortion high value multilayer ceramic capacitor | | | | |
| | | | Class 1 | | Class 2 | | |
| - . | | Standard | t | High Frequency Type | C≦10 µF | C>10 µF | |
| Test | Preconditioning | | None | | Thermal treatment (a | t 150°C for 1hr) Note 2 | |
| Methods and Remarks | Measuring frequency | | 1MHz±10% | | 1kHz±10% | 120±10Hz | |
| Remarks | Measuring voltage Note | | 0.5 to ! | 5Vrms | 1±0.2Vrms | 0.5±0.1rms | |
| | Bias application | | | | one | | |

| Temperature Specified | Standard | | C < 30pF : Q ≥ 400 + 20C C ≥ 30pF : Q ≥ 1000 (C:Nominal capacitance) | | | | | |
|-----------------------|---------------------------------|---------------------|---|------------------------------|---------------------------|---|-------------|--|
| Value | Compensating(Class1) | High Frequency Type | | Refer | to detailed specification | | | |
| | High Permittivity (Class2) Note | | 1 | BJ, B7, C6, C7, D7:2.5% max. | | | | |
| | | | | Class 1 | | Class 2 | | |
| | | | Standard | | High Frequency Type | C≦10 <i>µ</i> F | C>10 µF | |
| | Preconditioning | | | None | | Thermal treatment (at 150°C for 1hr) Note 2 | | |
| Test | Measuring frequey | | 1MHz±10 | 0% | 1GHz | 1kHz±10% | 120±10Hz | |
| Methods and | Measuring voltage Note | 1 | | 0.5 to | 5Vrms | 1±0.2Vrms | 0.5±0.1Vrms | |
| Remarks | Bias application | | | None | | | | |
| | High Frequency Type | | | | | | | |
| | Measuring equipment | : HP | 4291A | | | | | |
| | Measuring jig | : HP | 16192A | | | | | |

| | | | Temperature Characteristic [p | | | C] Tole | erance [ppm/°C] | |
|--------------------|----------------------------------|---------------------|-------------------------------|-----------------------|--------------------|------------------|--------------------|--|
| | | Ct and and | C□: | 0 | CG,CH, CJ, (| СК | G: ±30 H: ±60 | |
| | Temperature Compensating(Class1) | Standard | U□ : | — 750 | UJ, UK | | J: ±120 K: ±250 | |
| , | | SL : | +350 to −100 | 0 | | | | |
| | • | High Eraguanay Tyna | Tem | Temperature Character | | C] Tole | Tolerance [ppm/°C] | |
| | | nigh Frequency Type | C□: | 0 | CH | | H: ±60 | |
| Specified Value | | | | Specification | Capacitance | Reference | Temperature Range | |
| value | | | | opcomodicion | change | temperature | Tomporacaro riango | |
| | | | BJ | В | ±10% | 20°C | −25 to +85°C | |
| | | | В | X5R | ±15% | 25°C | -55 to +85°C | |
| | U: 1 D :::::::: (OL 0) | | В7 | X7R | ±15% | 25°C | −55 to +125°C | |
| | High Permittivity (Class2) | | C6 | X6S | ±22% | 25°C | −55 to +105°C | |
| | | | C7 | X7S | ±22% | 25°C | −55 to +125°C | |
| | | | D7 | X7S | +22/-33% | 25°C | −55 to +125°C | |
| | | | LD(※) | X5R | ±15% | 25°C | −55 to +85°C | |
| | | | Note: | VID Low diete | rtion high value i | multilavar aaran | io consoiter | |

Class 1

Capacitance at 20° C and 85° C shall be measured in thermal equilibrium, and the temperature characteristic shall be calculated from the following equation.

$$\frac{(C_{85}-C_{20})}{C_{20}\times\Delta T} \times 10^{6} (ppm/^{\circ}C) \Delta T = 65$$

Test Methods and Remarks

Class 2

Capacitance at each step shall be measured in thermal equilibrium, and the temperature characteristic shall be calculated from the following equation

| Step | В | X5R, X7R, X6S, X7S, X7T | | | |
|------|-------------------------------|-------------------------|--|--|--|
| 1 | Minimum operating temperature | | | | |
| 2 | 20°C | 25°C | | | |
| 3 | Maximum operating temperature | | | | |
| | | | | | |

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 $\frac{(C-C_2)}{C_2} \times 100(\%)$

C : Capacitance in Step 1 or Step 3

C2 : Capacitance in Step 2

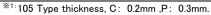
High Permittivity (Class2)

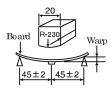
| 9. Deflection | | | | |
|--------------------|----------------------|---------------------|----------------------------------|---|
| | Temperature | Standard | Appearance Capacitance change | : No abnormality : Within $\pm 5\%$ or ± 0.5 pF, whichever is larger. |
| Specified Value | Compensating(Class1) | High Frequency Type | Appearance Cpaitance change | : No abnormality : Within±0.5 pF |
| Value | | | Appearance | : No abnormality |

Test Board

Methods and Remarks

| | Multilayer Ceramic Capacitors 042, 063, **105 Type The other types | | | | |
|-----------|--|-------|--|--|--|
| | | | | | |
| Board | Glass epoxy-resin substrate | | | | |
| Thickness | 0.8mm | 1.6mm | | | |
| Warp | 1mm (Soft Termination type:3mm) | | | | |
| Duration | 10 : | sec. | | | |





Capacitance change :Within $\pm 12.5\%(BJ, B7, C6, C7, D7, LD(\%))$ Note: %LD Low distortion high value multilayer ceramic capacitor

(Unit: mm

Capacitance measurement shall be conducted with the board bent

| 10. Body Stren | gth | | |
|--------------------------------|---|---------------------|---------------------------|
| | Temperature | Standard | - |
| Specified Value | Compensating(Class1) | High Frequency Type | No mechanical damage. |
| Value | High Permittivity (Class2) |) | - |
| Test Methods and Remarks | High Frequency Type Applied force : 5N Duration : 10 sec. | Pres Pres | R0.5 Pressing Jig Chip A |

| 11. Adhesive S | 11. Adhesive Strength of Terminal Electrodes | | | | | |
|--------------------|--|---------------------|----------------------|-----------------------|--|--|
| | Temperature | Standard | | | | |
| Specified Value | Compensating(Class1) | High Frequency Type | No terminal separati | on or its indication. | | |
| | High Permittivity (Class2) | | | | | |
| | | Multilayer Ceram | ic Capacitors | Hooked jig | | |
| Test | | 042, 063 Type | 105 Type or more | | | |
| Methods and | Applied force | 2N | 5N | R=05 Doard | | |
| Remarks | Duration | 30±5 | sec. |] ←Chip | | |
| | | | | Chip Chip | | |

| 12. Solderabilit | у | | | | |
|---------------------|----------------------------|---------------------|--------------|--|--|
| Specified Value | Temperature | Standard | | | |
| | Compensating(Class1) | High Frequency Type | At least 95% | At least 95% of terminal electrode is covered by new solder. | |
| | High Permittivity (Class2) | | | | |
| - . | | Eutectic so | older | Lead-free solder | |
| Test Methods and | Solder type | H60A or H | 63A | Sn-3.0Ag-0.5Cu | |
| Remarks | Solder temperature | 230±5° | С | 245±3°C | |
| Remarks | Duration | | 4±1 sec. | | |

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| 13. Resistance | to Soldering | | | | |
|------------------------|-----------------------------------|--|--|--|---|
| | Temperature | Standard | Appearance Capacitance change Q Insulation resistance Withstanding voltage | : No abnormality : Within ±2.5% or ±0 : Initial value : Initial value (between terminals) | .25pF, whichever is larger. : No abnormality |
| Specified Value | Compensating(Class1) | High Frequency Type | Appearance : No abnormality Capacitancecange : Within ±2.5% Q : Initial value Insulation resistance : Initial value Withstanding voltage (between terminals) | | : No abnormality |
| | High Permittivity (Class2) Note 1 | | Appearance Capactace change Dissipation factor Insulation resistance Withstanding voltage Note: **LD Low distort | : No abormality : Within ±7.5%(BJ, B' : Initial value : Initial value (between terminals): tion high value multilaye | No abnormality |
| | | | lss 1 | | |
| | | 042, 063 Type | 1 | 05 Type | |
| | Preconditioning | | None | | |
| | Preheating | 150°C, 1 to 2 min. | | 0°C, 2 to 5 min. 00°C, 2 to 5 min. | |
| | Solder temp. | | 270±5°C | | |
| | Duration | 3±0.5 sec. | | | |
| Γest | Recovery | 6 to 24 hrs (Standard condition) Noe 5 | | | |
| Methods and Remarks | | | | Class 2 | |
| | | 042,063 Type | | 07, 212 Type | 316, 325 Type |
| | Preconditioning | . ,,,, | | (at 150°C for 1 hr) No | |
| | Preheating | 150°C, 1 to 2 min. | 80 to 10 | 0°C, 2 to 5 min. | 80 to 100°C, 5 to 10 min. 150 to 200°C, 5 to 10 min. |
| | Solder temp. | | | 70±5°C | |
| | Duration | | | ±0.5 sec. | |
| | Recovery | | | ndard condition)Note 5 | i |

| 14. Temperatur | re Cycle (Thermal Shock) | | | | | | |
|--------------------------------|---------------------------|---|-------------------|---|--|-------------------------------------|--|
| | Temperature | Standard | | Appearance Capacitance change Q Insulation resistance Withstanding voltage | : No abnormality : Within ±2.5% or ±0.25 : Initial value : Initial value (between terminals) : N | - | |
| Specified Value | Compensating(Class1) | High Frequency | [,] Туре | Appearance Capacitance change Q Insulation resistance Withstanding voltage | : No abnormality : Within ±0.25pF : Initial value : Initial value (between terminals) : N | o abnormality | |
| | High Permittivity (Class2 |) Note 1 | | Appearance : No abnormality Capacitance change : Within ±7.5% (BJ, B7, C6, C7, D7, LD(※)) Dissipation factor : Initial value Insulation resistance : Initial value Withstanding voltage (between terminals) : No abnormality Note: **LD Low distortion high value multilayer ceramic capacitor | | o abnormality | |
| | | | C | Class 1 | | Class 2 | |
| | Preconditioning | | | None | Thermal trea | tment (at 150°C for 1 hr) Note 2 | |
| Test Methods and Remarks | 1 cycle | StepTemperature1Minimum operating t2Normal temper3Maximum operating t4Normal temper | | nting temperature emperature ting temperature | Time (min.) 30 ± 3 $2 \text{ to } 3$ 30 ± 3 $2 \text{ to } 3$ | | |
| | Number of cycles | | | | 5 times | | |
| | Recovery | 6 to 24 hr | S (Stan | dard condition)Note 5 | 24±2 hrs (5 | Standard condition)Note 5 | |

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| 15. Humidity (| Steady State) | | | |
|------------------------|------------------------------------|---------------------|---|--|
| | Temperature Compensating(Class1 | | | : No abnormality : Within $\pm 5\%$ or $\pm 0.5 pF$, whichever is larger. : $C < 10 pF$: $Q \ge 200 + 10 C$ $10 \le C < 30 pF$: $Q \ge 275 + 2.5 C$ $C \ge 30 pF$: $Q \ge 350$ (C : Nominal capacitance) : $1000 \text{ M} \Omega \text{ min}$. |
| Specified Value | | High Frequency Type | Appearance Capacitance change Insulation resistance | : No abnormality : Within $\pm 0.5 \text{pF}$, : 1000 M Ω min. |
| | High Permittivity(Class2) Note 1 | | Insulation resistance | : No abnormality : Within \pm 12.5% (BJ, B7, C6, C7, D7, LD($\stackrel{.}{\otimes}$)) : 5.0% max. (BJ, B7, C6, C7, D7, LD($\stackrel{.}{\otimes}$)) : 50 M $\Omega\mu$ F or 1000 M Ω whichever is smaller. on high value multilayer ceramic capacitor |
| | | | ass 1 | Class 2 |
| _ | | Standard | High Frequency Type | |
| Test | Preconditioning | | one co Lo°o | Thermal treatment (at 150°C for 1 hr) Note 2 |
| Methods and Remarks | Temperature | 40±2°C | 60±2°C | 40±2°C 90 to 95%RH |
| Remarks | Humidity Duration | | 95%R⊓ 4/−0 hrs | 90 to 95%RH 500+24/-0 hrs |
| | Recovery | | ard condition)Note 5 | 24±2 hrs (Standard condition) Note 5 |

| 16. Humidity Lo | pading | | | |
|--------------------|--------------------------|---------------------|---|--|
| | Temperature | Standard | Appearance Capacitance change Q Insulation resistance | : No abnormality : Within ±7.5% or ±0.75pF, whichever is larger. : C < 30pF: Q ≥ 100+10C/3 C≥30pF: Q≥200 (C:Nominal capacitance) : 500 MΩ min. |
| Specified Value | Compensating(Class1) | High Frequency Type | $\begin{array}{lll} \mbox{Appearance} & : \mbox{No abnormality} \\ \mbox{Capacitance change} & : \mbox{C} \leq 2 \mbox{pF} : \mbox{Within } \pm 0.4 \mbox{ pF} \\ \mbox{C} > 2 \mbox{pF} : \mbox{Within } \pm 0.75 \mbox{ pF} \\ \mbox{(C: Nominal capacitance)} \\ \mbox{Insulation resistance} & : 500 \mbox{ M} \Omega \mbox{ min.} \end{array}$ | |
| | High Permittivity(Class2 |) Note 1 | Appearance Capacitance change Dissipation factor Insulation resistance Note: ※LD Low distor | : No abnormality : Within \pm 12.5% (BJ, B7, C6, C7, D7, LD($\!$ |
| | | C | Class 1 | Class 2 |
| | | Standard | High Frequency Typ | pe All items |
| | Preconditioning | | None | Voltage treatment (Rated voltage are applied for 1 hour at 40°C) Note 3 |
| Test | Temperature | 40±2°C | 60±2°C | 40±2°C |
| Methods and | Humidity | 90 t | o 95%RH | 90 to 95%RH |
| Remarks | Duration | 500+ | 24/-0 hrs | 500+24/-0 hrs |
| | Applied voltage | Rate | d voltage | Rated voltage |
| | Charge/discharge current | 50r | mA max. | 50mA max. |
| | Recovery | 6 to 24 hrs (Stan | dard condition)Note 5 | 24±2 hrs(Standard condition) Note 5 |

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| 17. High Tempe | erature Loading | | | | | | |
|--------------------|-------------------------------------|--------------------------------------|--|---|---|------------------------|--|
| | Temperature Compensating(Class1) | Standard | Appearance Capacitance change Q Insulation resistance | | : C<10pF: Q≥200+10C 10≤C<30pF:Q≥275+2.5C C≥30pF: Q≥350(C:Nominal capacitance) | | |
| Specified Value | | High Frequency Type | Appearance : No abnormality capacitance change : Within $\pm 3\%$ or ± 0.3 pF, whichever is larger. Insulation resistance : 1000 M Ω min. | | | | |
| | High Permittivity (Class2) Note 1 | | Appearance Capacitance change Dissipation factor Insulation resistance Note: **LD Low dis* | : 5.0% max.(BJ, E | (BJ, B7, C6, C7, D 37, C6, C7, D7, LDG 00 MΩ whichever is tilayer ceramic capa | ※)) s smaller. | |
| | | Class 1 Standard High Frequency Type | | Class 2 | | | |
| | | | | BJ, LD(※) | C6 | B7, C7, D7 | |
| | Preconditioning | None | | Voltage treatment (Twice the rated voltage shall be applied for 1 hour at 85°C, 105°C or 125°C) Note 3, 4 | | | |
| Test | Temperature | Maximum operati | ng temperature | Maximum operating temperature | | | |
| Methods and | Duration | 1000+48 | /-0 hrs | | 1000 + 48 / -0 hr | 'S | |
| Remarks | Applied voltage | Rated vol | ltage × 2 | Rated voltage × 2 Note 4 | | | |
| | Charge/discharge current | 50mA | max. | 50mA max. | | | |
| | Recovery | 6 to 24hr(Standard | condition) Note 5 | 24±2 hr | s (Standard condit | tion) Note 5 | |
| | | | Note | *LD Low distortion | n high value multil | ayer ceramic capacitor | |

Note 1 The figures indicate typical specifications. Please refer to individual specifications in detail.

- Note 2 Thermal treatment : Initial value shall be measured after test sample is heat-treated at $150 \pm 0/-10^{\circ}$ C for an hour and kept at room temperature for 24 ± 2 hours.
- Note 3 Voltage treatment: Initial value shall be measured after test sample is voltage—treated for an hour at both the temperature and voltage specified in the test conditions, and kept at room temperature for 24±2hours.
- Note 4 150% of rated voltage is applicable to some items. Please refer to their specifications for further information.
- Note 5 Standard condition: Temperature: 5 to 35°C, Relative humidity: 45 to 85 % RH, Air pressure: 86 to 106kPa When there are questions concerning measurement results, in order to provide correlation data, the test shall be conducted under the following condition.

Temperature: $20\pm2^{\circ}$ C, Relative humidity: 60 to 70 % RH, Air pressure: 86 to 106kPa Unless otherwise specified, all the tests are conducted under the "standard condition".

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Medium-High Voltage Multilayer Ceramic Capacitor

■RELIABILITY DATA

| 1. Operating Tempe | rature Range |
|----------------------|--|
| | Temperature Compensating(High Frequency type) CG(COG) : -55 to +125°C |
| Specified Value | High permittivity |
| | X7R, X7S : −55 to +125°C |
| | X5 : −55 to +85°C |
| | B : -25 to +85°C |
| 2. Storage Tempera | ture Range |
| | Temperature Compensating(High Frequency type) |
| | CG(C0G) : -55 to +125°C |
| Specified Value | High permittivity |
| • | X7R, X7S : −55 to +125°C |
| | X5R : −55 to +85°C |
| | B : -25 to +85°C |
| 3. Rated Voltage | |
| Specified Value | 100VDC(HMK,HMJ), 250VDC(QMK,QMJ,QVS), 630VDC(SMK,SMJ) |
| | |
| 4. Withstanding Vol | tage (Between terminals) |
| Specified Value | No breakdown or damage |
| Test Methods and | Applied voltage : Rated voltage × 2.5(HMK,HMJ), Rated voltage × 2(QMK,QMJ,QVS), Rated voltage × 1.2(SMK,SMJ) |
| Remarks | Duration : 1 to 5sec. |
| | Carge/discharge current : 50mA max. |
| 5. Insulation Resist | ance |
| | Temperature Compensating(High Frequency type) |
| | 10000M Ω min |
| Specified Value | |

Test Methods and

Remarks

High permittivity

Applied voltage

Charge/discharge current

Duration

 $100 M\,\Omega\mu\!F$ or $10G\,\Omega$ whichever is smaller.

:60±5sec.

: 50mA max.

| 6. Capacitance (To | ance (Tolerance) | | | | | | |
|--------------------|---|----------------|--|--|--|--|--|
| Specified Value | Temperature Compensating(High Frequency type) ± 0.1 pF (C < 5pF) ± 0.2 5pF (C < 10pF) ± 0.5 pF (5pF \leq C < 10pF) ± 2 %(C=10pF) ± 5 %(C \geq 10pF) | | | | | | |
| | High permittivity | | | | | | |
| | ±10%, ±20% | | | | | | |
| | Temperature Compensating(High Frequency type) | | | | | | |
| | Measuring frequency | : 1MHz±10% | | | | | |
| | Measuring voltage | : 0.5 to 5Vrms | | | | | |
| Test Methods and | Bias application | : None | | | | | |
| Remarks | High permittivity | | | | | | |
| | Measuring frequency | : 1kHz±10% | | | | | |
| | Measuring voltage | : 1±0.2Vrms | | | | | |
| | Bias application | : None | | | | | |

: Rated voltage (HMK,HMJ, QMK,QMJ,QVS), 500V(SMK,SMJ)

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| 7. Q or Dissipation | Factor | | | | | |
|---------------------|---|----------------|--|--|--|--|
| | Temperature Compensating(High Frequency type) | | | | | |
| | C<30pF: Q≧800+20C | | | | | |
| | C≧30pF : Q≧1400 C:Normal Capacitance(/pF) | | | | | |
| Specified Value | | | | | | |
| | High permittivity | | | | | |
| | 3.5%max (HMK,HMJ) | | | | | |
| | 2.5%max(QMK,QMJ, SMK,SMJ) | | | | | |
| | Temperature Compensating(High Frequency type) | | | | | |
| | Measuring frequency | : 1MHz±10% | | | | |
| | Measuring voltage | : 0.5 to 5Vrms | | | | |
| Test Methods and | Bas application | : None | | | | |
| Remarks | High permittivity | | | | | |
| | Measuring frequency | : 1kHz±10% | | | | |
| | Measuring voltage | : 1±0.2Vrms | | | | |
| | Bas application | : None | | | | |

| 8. Temperature Cha | aracteristic of | F Capacitance | | | | |
|-----------------------------|---|--|---------------------------|---|--|--|
| | Temperature Compensating(High Frequency type) COG :±30ppm(25 to +125°C) | | | | | |
| Specified Value | High permittivity B : ±10%(-25 to +85°C) X5R : ±15%(-55 to +85°C) X7R : ±15%(-55 to +125°C) X7S : ±22%(-55 to +125°C) | | | | | |
| | Capacitance following equal $\frac{(C_{85}\!-\!C_{25})}{C_{25}\!\times\!\Delta\!T}$ High permitt | uation.) × 10 ⁶ × [ppm/°C] tivity e value at each step sl | nall be measured in therm | al equilibrium, and the temperature characteristic shall be calculated from the | | |
| Test Methods and Remarks | Step | В | X5R, X7R, X7S | | | |
| Remarks | 1 | Minimum operat | ting tempeature | | | |
| | 2 | 20°C | 25°C | | | |
| | 3 | Maximum operat | ting temperature | | | |
| | = | × 100(%) itance value in Step 1 | or Step 3 | | | |

| 9. Deflection | |
|-----------------------------|--|
| Specified Value | Temperature Compensating(High Frequency type) Appearance : No abnormality Capacitance change : ±5% or ±0.5pF, whichever is larger. |
| opecined value | High permittivity Appearance : No abnormality Capacitance change : Within±10% |
| Test Methods and Remarks | Warp : 1mm (Soft Termination type:3mm) Duration : 10sec. Test board : Glass epoxy-resin substrate Thicknss : 1.6mm Board Warp Warp (Unit: mm) |
| | Capacitance measurement shall be conducted with the board bent. |

C2 : Capacitance value in Step 2

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10. Adhesive Strength of Terminal Electrodes Specified Value No terminal separation or its indication. Temperature Compensating(High Frequency type) Applied force : 2N Hooked jig Duration : 10±5sec. Board Test Methods and Remarks High permittivity Applied force : 5N Hooked jig Duration : 30±5sec. Board

| 11. Solderability | | | | | | | |
|-------------------|---|-----------------|------------------|--|--|--|--|
| Specified Value | At least 95% of terminal electrode is covered by new solder | | | | | | |
| | | Eutectic solder | Lead-free solder | | | | |
| Test Methods and | Solder type | H60A or H63A | Sn-3.0Ag-0.5Cu | | | | |
| Remarks | Solder temperature | 230±5°C | 245±3°C | | | | |
| | Duration 4±1 sec. | | | | | | |

| 12. Resistance to Soldering | | | | | | | | | |
|-----------------------------|---|--|--|--|--|--|--|--|--|
| | Temperature Compensating(High Frequency type) | | | | | | | | |
| | Appearance : No abnormality | | | | | | | | |
| | Capacitance change | : C※≦10pF :±0.25pF C※>10pF :±2.5% ※Normal capacitance | | | | | | | |
| | Insulation resistance | : Initial value | | | | | | | |
| | Withstanding voltage | (between terminals): No abnormality | | | | | | | |
| Specified Value | High permittivity | | | | | | | | |
| | Appearance | : No abnormality | | | | | | | |
| | Capacitance change | : Within±15%(HMK,HMJ), ±10%(QMK,QMJ, SMK,SMJ) | | | | | | | |
| | Dissipation factor | : Inital value | | | | | | | |
| | Insulation resistance | : Initial value | | | | | | | |
| | Withstanding voltage | (between terminals): No abnormality | | | | | | | |
| | Preconditioning | : Thermal treatment(at 150°C for 1hr) Note1 (Only High permittivity) | | | | | | | |
| Test Methods and | Solder temperature | : 270±5℃ | | | | | | | |
| Remarks | Duration | : 3±0.5sec. | | | | | | | |
| 1 Ciliai No | Preheating conditions | : 80 to 100°C, 2 to 5 min. 150 to 200°C, 2 to 5min. | | | | | | | |
| | Recovery | : 24 ± 2 hrs under the stadard condition Note3 | | | | | | | |

| 13. Temperature C | 1 | | | | |
|-------------------|--------------------|----------------|--|-------------|--|
| | Temperati | ure Compens | ating(High Frequency type) | | |
| | Appearance | | : No abnormality | | |
| | | ce change | : C※≦10pF :±0.25% C※>10pF :±2.5% | | |
| | Insulation | resistance | : Initial value | | |
| | Withstand | ing voltage | (between terminals): No abnormality | | |
| Specified Value | High permittivity | | | | |
| | Appearance | | : No abnormality | | |
| | Capacitance change | | : Within±15%(HMK,HMJ), ±7.5%(QMK,QMJ, SMK,SMJ) | | |
| | Dissipation factor | | : Initial value | | |
| | Insulation | resistance | : Initial value | | |
| | Withstand | ing voltage | (between terminals): No abnormality | | |
| | Precondit | ioning : Therr | mal treatment (at 150°C for 1hr) Note1 | | |
| | Conditions | for 1 cycle | | | |
| | Step | | temperature(°C) | Time (min.) | |
| Test Methods and | 1 | | Minimum operating temperature | 30±3min. | |
| Remarks | 2 | | Normal temperature | 2 to 3min. | |
| Remarks | 3 | | Maximum operating temperature | 30±3min. | |
| | 4 | | Normal temperature | 2 to 3min. | |

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| 14. Humidity (Stea | 14. Humidity (Steady state) | | | | | | | |
|-----------------------------|--|--|--|--|--|--|--|--|
| | Temperature Compensati Appearance Capacitance change Insulation resistance | ng(High Frequency type) : No abnormality : C※≦10pF :±0.5pF C※>10pF :±5% ※Normal capacitance : 1000M Ωmin | | | | | | |
| Specified Value | High permittivity Appearance Capacitance change Dissipation factor Insulation resistance | : No abnormality : Within \pm 15% : 7%max (HMK,HMJ), 5%max (QMK,QMJ, SMK,SMJ). : 25M Ω $_{\it L}\!$ | | | | | | |
| Test Methods and Remarks | Preconditioning Temperature Humidity Duration Recovery | : Thermal treatment (at 150°C for 1hr) Note1 (Only High permittivity) : 40 ± 2 °C : 90 to 95%RH : $500 +24/-0$ hrs : 24 ± 2 hrs under the standard condition Note3 | | | | | | |

| 15. Humidity Loading | | | | | | | |
|----------------------|---|--|--|--|--|--|--|
| | Temperature Compensating(High Frequency type) | | | | | | |
| | Appearance | : No abnormality | | | | | |
| | Capacitance change | : C※≦2.0pF:±0.4pF 2.0pF <c≦10pf: c※="" ±0.75pf="">10pF:±7.5%</c≦10pf:> | | | | | |
| | | : %Normal capacitance | | | | | |
| | Insulation resistance | : 500M Ωmin | | | | | |
| Specified Value | | | | | | | |
| | High permittivity | | | | | | |
| | Appearance | : No abnormality | | | | | |
| | Capacitance change | : Within±15% | | | | | |
| | Dissipation factor | : 7%max(HMK,HMJ), 5%max(QMK,QMJ, SMK,SMJ). | | | | | |
| | Insulation resistance | : 10M $\Omega\mu$ or 500M Ω whichever is smaller. | | | | | |
| | According to JIS 5102 claus | se 9.9. | | | | | |
| | Preconditioning | : Voltage treatment Note2 (Only High permittivity) | | | | | |
| | Temperature | : 40±2°C | | | | | |
| Test Methods and | Humidity | : 90 to 95%RH | | | | | |
| Remarks | Applied voltage | : Rated voltage | | | | | |
| | Charge/discharge current | : 50mA max. | | | | | |
| | Duration | : 500 + 24/-0 hrs | | | | | |
| | Recovery | : 24±2hrs under the standard condition Note3 | | | | | |

| 16. High Temperatu | ure Loading | | | | | | |
|--------------------|---|--|--|--|--|--|--|
| | Temperature Compensating(High Frequency type) | | | | | | |
| | Appearance | : No abnormality | | | | | |
| | Capacitance change | : C※≦10pF:±0.3pF C※>10pF:±3% | | | | | |
| | Insulation resistance | :1000M Ωmin | | | | | |
| Specified Value | High permittivity | | | | | | |
| | Appearance | : No abnormality | | | | | |
| | Capacitance change | : Within±15% | | | | | |
| | Dissipation factor | : 7%max(HMK,HMJ), 5%max(QMK,QMJ, SMK,SMJ). | | | | | |
| | Insulation resistance | : 50M $\Omega\mu\!\!\!/F$ or 1000M Ω whichever is smaller. | | | | | |
| | According to JIS 5102 claus | se 9.10. | | | | | |
| | Preconditioning | : Voltage treatment Note2 (Only High permittivity) | | | | | |
| Test Methods and | Temperature | : Maximum operating temperature | | | | | |
| Remarks | Applied voltage | : Rated voltage × 2(HMK,HMJ,QVS) Rated voltage × 1.5(QMK,QMJ) Rated voltage × 1.2(SMK,SMJ) | | | | | |
| Remarks | Charge/discharge current | : 50mA max. | | | | | |
| | Duration | : 1000 + 24/-0 hrs | | | | | |
| | Recovery | : 24±2hrs under the standard condition Note3 | | | | | |

Note1 Thermal treatment : Initial value shall be measured after test sample is heat-treated at $150 \pm 0/-10^{\circ}\text{C}$ for an hour and kept at room temperature

for 24 ± 2 hours.

Note2 Voltage treatment : Initial value shall be measured after test sample is voltage-treated for an hour at both the temperature and voltage specified in

the test conditions, and kept at room temperature for 24 \pm 2hours.

Note3 Standard condition : Temperature: 5 to 35°C, Relative humidity: 45 to 85 % RH, Air pressure: 86 to 106kPa

When there are questions concerning measurement results, in order to provide correlation data, the test shall be conducted

under the following condition.

Temperature: $20\pm2^{\circ}$ C, Relative humidity: 60 to 70 % RH, Air pressure: 86 to 106kPa Unless otherwise specified, all the tests are conducted under the "standard condition".

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Precautions on the use of Multilayer Ceramic Capacitors

■PRECAUTIONS

1. Circuit Design

- ◆ Verification of operating environment, electrical rating and performance
 - A malfunction of equipment in fields such as medical, aerospace, nuclear control, etc. may cause serious harm to human life or have severe social ramifications.

Therefore, any capacitors to be used in such equipment may require higher safety and reliability, and shall be clearly differentiated from them used in general purpose applications.

Precautions

- ◆Operating Voltage (Verification of Rated voltage)
 - 1. The operating voltage for capacitors must always be their rated voltage or less.
 - If an AC voltage is loaded on a DC voltage, the sum of the two peak voltages shall be the rated voltage or less.
 - For a circuit where an AC or a pulse voltage may be used, the sum of their peak voltages shall also be the rated voltage or less.
 - 2. Even if an applied voltage is the rated voltage or less reliability of capacitors may be deteriorated in case that either a high frequency AC voltage or a pulse voltage having rapid rise time is used in a circuit.

2. PCB Design

Precautions

- ◆Pattern configurations (Design of Land-patterns)
- 1. When capacitors are mounted on PCBs, the amount of solder used (size of fillet) can directly affect the capacitor performance. Therefore, the following items must be carefully considered in the design of land patterns:
 - (1) Excessive solder applied can cause mechanical stresses which lead to chip breaking or cracking. Therefore, please consider appropriate land-patterns for proper amount of solder.
 - (2) When more than one component are jointly soldered onto the same land, each component's soldering point shall be separated by solder-resist.
- ◆Pattern configurations (Capacitor layout on PCBs)

After capacitors are mounted on boards, they can be subjected to mechanical stresses in subsequent manufacturing processes (PCB cutting, board inspection, mounting of additional parts, assembly into the chassis, wave soldering of the boards, etc.). For this reason, land pattern configurations and positions of capacitors shall be carefully considered to minimize stresses.

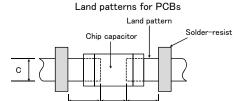
◆Pattern configurations (Design of Land-patterns)

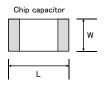
The following diagrams and tables show some examples of recommended land patterns to prevent excessive solder amounts.

- (1) Recommended land dimensions for typical chip capacitors
- Multilayer Ceramic Capacitors : Recommended land dimensions (unit: mm)

Wave-soldering

| Type | | 107 | 212 | 316 | 325 | |
|------|---|------------|------------|------------|------------|--|
| Size | L | 1.6 | 2.0 | 3.2 | 3.2 | |
| Size | W | 0.8 | 1.25 | 1.6 | 2.5 | |
| À | | 0.8 to 1.0 | 1.0 to 1.4 | 1.8 to 2.5 | 1.8 to 2.5 | |
| В | | 0.5 to 0.8 | 0.8 to 1.5 | 0.8 to 1.7 | 0.8 to 1.7 | |
| С | | 0.6 to 0.8 | 0.9 to 1.2 | 1.2 to 1.6 | 1.8 to 2.5 | |





Technical considerations

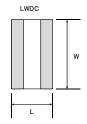
Reflow-soldering

| | Tellow Soldering | | | | | | | | |
|----|------------------|--------------|--------------|--------------|------------|------------|------------|------------|------------|
| | Туре | 042 | 063 | 105 | 107 | 212 | 316 | 325 | 432 |
| Si | L | 0.4 | 0.6 | 1.0 | 1.6 | 2.0 | 3.2 | 3.2 | 4.5 |
| SI | W | 0.2 | 0.3 | 0.5 | 0.8 | 1.25 | 1.6 | 2.5 | 3.2 |
| | Α | 0.15 to 0.25 | 0.20 to 0.30 | 0.45 to 0.55 | 0.8 to 1.0 | 0.8 to 1.2 | 1.8 to 2.5 | 1.8 to 2.5 | 2.5 to 3.5 |
| | В | 0.15 to 0.20 | 0.20 to 0.30 | 0.40 to 0.50 | 0.6 to 0.8 | 0.8 to 1.2 | 1.0 to 1.5 | 1.0 to 1.5 | 1.5 to 1.8 |
| | С | 0.15 to 0.30 | 0.25 to 0.40 | 0.45 to 0.55 | 0.6 to 0.8 | 0.9 to 1.6 | 1.2 to 2.0 | 1.8 to 3.2 | 2.3 to 3.5 |

Note: Recommended land size might be different according to the allowance of the size of the product.

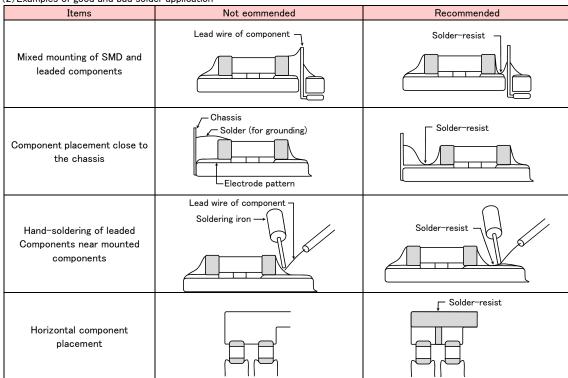
● LWDC: Recommended land dimensions for reflow-soldering

| | (unit: mm) | | | | | |
|--|------------|---|--------------|-------------|------------|--|
| | Type | | 105 | 107 | 212 | |
| | Size | L | 0.52 | 0.8 | 1.25 | |
| | Size | W | 1.0 | 1.6 | 2.0 | |
| | P | 4 | 0.18 to 0.22 | 0.25 to 0.3 | 0.5 to 0.7 | |
| | В | | 0.2 to 0.25 | 0.3 to 0.4 | 0.4 to 0.5 | |
| | С | | 0.9 to 1.1 | 1.5 to 1.7 | 1.9 to 2.1 | |



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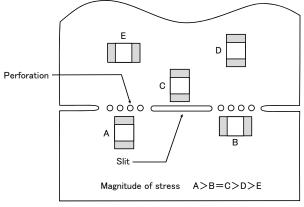
(2) Examples of good and bad solder application



- ◆Pattern configurations (Capacitor layout on PCBs)
 - 1-1. The following is examples of good and bad capacitor layouts; capacitors shall be located to minimize any possible mechanical stresses from board warp or deflection.

| Items | Not recommended | Recommended | |
|---------------------|-----------------|---|--|
| Deflection of board | | Place the product at a right angle to the direction of the anticipated mechanical stress. | |

1-2. The amount of mechanical stresses given will vary depending on capacitor layout. Please refer to diagram below.



1-3. When PCB is split, the amount of mechanical stress on the capacitors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, slit, V-grooving, and perforation. Thus, please consider the PCB, split methods as well as chip location.

3. Mounting

- ◆Adjustment of mounting machine
 - 1. When capacitors are mounted on PCB, excessive impact load shall not be imposed on them.
 - 2. Maintenance and inspection of mounting machines shall be conducted periodically.

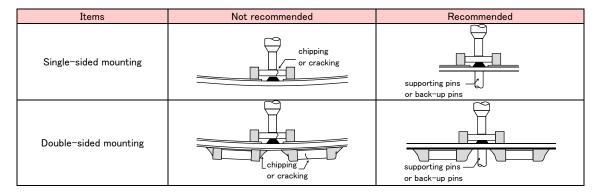
Precautions Selection of Adhesives

1. When chips are attached on PCBs with adhesives prior to soldering, it may cause capacitor characteristics degradation unless the following factors are appropriately checked: size of land patterns, type of adhesive, amount applied, hardening temperature and hardening period. Therefore, please contact us for further information.

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◆Adjustment of mounting machine

- 1. When the bottom dead center of a pick-up nozzle is too low, excessive force is imposed on capacitors and causes damages. To avoid this, the following points shall be considerable.
 - (1) The bottom dead center of the pick-up nozzle shall be adjusted to the surface level of PCB without the board deflection.
 - (2) The pressure of nozzle shall be adjusted between 1 and 3 N static loads.
 - (3) To reduce the amount of deflection of the board caused by impact of the pick-up nozzle, supporting pins or back-up pins shall be used on the other side of the PCB. The following diagrams show some typical examples of good and bad pick-up nozzle placement:



Technical considerations

2. As the alignment pin is worn out, adjustment of the nozzle height can cause chipping or cracking of capacitors because of mechanical impact on the capacitors.

To avoid this, the monitoring of the width between the alignment pins in the stopped position, maintenance, check and replacement of the pin shall be conducted periodically.

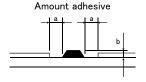
◆Selection of Adhesives

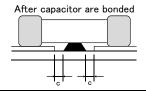
Some adhesives may cause IR deterioration. The different shrinkage percentage of between the adhesive and the capacitors may result in stresses on the capacitors and lead to cracking. Moreover, too little or too much adhesive applied to the board may adversely affect components. Therefore, the following precautions shall be noted in the application of adhesives.

- (1) Required adhesive characteristics
 - a. The adhesive shall be strong enough to hold parts on the board during the mounting & solder process.
 - b. The adhesive shall have sufficient strength at high temperatures.
 - c. The adhesive shall have good coating and thickness consistency.
 - d. The adhesive shall be used during its prescribed shelf life.
 - e. The adhesive shall harden rapidly.
 - f. The adhesive shall have corrosion resistance.
 - g. The adhesive shall have excellent insulation characteristics.
 - h. The adhesive shall have no emission of toxic gasses and no effect on the human body.
- $\begin{tabular}{ll} (2) The recommended amount of adhesives is as follows; \\ \end{tabular}$

[Recommended condition]

| Figure | 212/316 case sizes as examples |
|--------|----------------------------------|
| а | 0.3mm min |
| b | 100 to 120 μm |
| С | Adhesives shall not contact land |





4. Soldering

Precautions

Technical

considerations

◆Selection of Flux

Since flux may have a significant effect on the performance of capacitors, it is necessary to verify the following conditions prior to use;

- (1) Flux used shall be less than or equal to 0.1 wt%(in Cl equivalent) of halogenated content. Flux having a strong acidity content shall not be applied.
- (2) When shall capacitors are soldered on boards, the amount of flux applied shall be controlled at the optimum level.
- (3) When water-soluble flux is used, special care shall be taken to properly clean the boards.

◆ Soldering

Temperature, time, amount of solder, etc. shall be set in accordance with their recommended conditions. Sn-Zn solder paste can adversely affect MLCC reliability.

Please contact us prior to usage of Sn-Zn solder.

◆Selection of Flux

1-1. When too much halogenated substance (Chlorine, etc.) content is used to activate flux, or highly acidic flux is used, it may lead to corrosion of terminal electrodes or degradation of insulation resistance on the surfaces of the capacitors.

- 1-2. Flux is used to increase solderability in wave soldering. However if too much flux is applied, a large amount of flux gas may be emitted and may adversely affect the solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.
- 1-3. Since the residue of water-soluble flux is easily dissolved in moisture in the air, the residues on the surfaces of capacitors in high humidity conditions may cause a degradation of insulation resistance and reliability of the capacitors. Therefore, the cleaning methods and the capability of the machines used shall also be considered carefully when water-soluble flux is used.

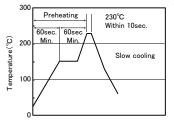
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◆Soldering

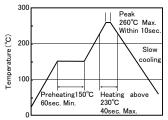
- · Ceramic chip capacitors are susceptible to thermal shock when exposed to rapid or concentrated heating or rapid cooling.
- · Therefore, the soldering must be conducted with great care so as to prevent malfunction of the components due to excessive thermal shock
- Preheating: Capacitors shall be preheated sufficiently, and the temperature difference between the capacitors and solder shall be within 100 to 130°C.
- · Cooling: The temperature difference between the capacitors and cleaning process shall not be greater than 100°C.

[Reflow soldering]

[Recommended conditions for eutectic soldering]

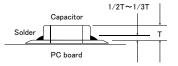


[Recommended condition for Pb-free soldering]



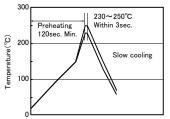
Caution

- 1The ideal condition is to have solder mass(fillet) controlled to 1/2 to 1/3 of the thickness of a capacitor.
- ②Because excessive dwell times can adversely affect solderability, soldering duration shall be kept as close to recommended times as possible.
- 3 Allowable number of reflow soldering: 2 times max.

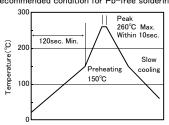


[Wave soldering]

[Recommended conditions for eutectic soldering]



[Recommended condition for Pb-free soldering]

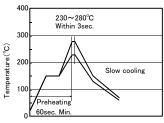


Caution

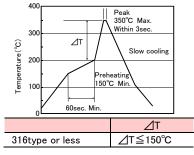
- ①Wave soldering must not be applied to capacitors designated as for reflow soldering only.
- ②Allowable number of wave soldering: 1 times max.

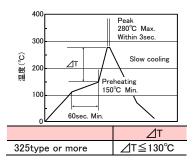
[Hand soldering]

[Recommended conditions for eutectic soldering]



[Recommended condition for Pb-free soldering]





Caution

- ①Use a 50W soldering iron with a maximum tip diameter of 1.0 mm.
- 2The soldering iron shall not directly touch capacitors.
- 3 Allowable number of hand soldering: 1 times max.

5. Cleaning Cleaning conditions 1. When PCBs are cleaned after capacitors mounting, please select the appropriate cleaning solution in accordance with the intended use Precautions of the cleaning. (e.g. to remove soldering flux or other materials from the production process.) 2. Cleaning condition shall be determined after it is verified by using actual cleaning machine that the cleaning process does not affect capacitor's characteristics. 1. The use of inappropriate cleaning solutions can cause foreign substances such as flux residue to adhere to capacitors or deteriorate their outer coating, resulting in a degradation of the capacitor's electrical properties (especially insulation resistance). 2. Inappropriate cleaning conditions (insufficient or excessive cleaning) may adversely affect the performance of the capacitors. In the case of ultrasonic cleaning, too much power output can cause excessive vibration of PCBs which may lead to the Technical cracking of capacitors or the soldered portion, or decrease the terminal electrodes' strength. Therefore, the following conditions shall considerations be carefully checked; Ultrasonic output: 20 W/Q or less Ultrasonic frequency: 40 kHz or less Ultrasonic washing period: 5 min. or less

6. Resin coating and mold

Precautions

- 1. With some type of resins, decomposition gas or chemical reaction vapor may remain inside the resin during the while left under normal storage conditions resulting in the deterioration of the capacitor's performance.
- 2. When a resin's hardening temperature is higher than capacitor's operating temperature, the stresses generated by the excessive heat may lead to damage or destruction of capacitors.

The use of such resins, molding materials etc. is not recommended.

7. Handling

◆Splitting of PCB

1. When PCBs are split after components mounting, care shall be taken so as not to give any stresses of deflection or twisting to the board.

2. Board separation shall not be done manually, but by using the appropriate devices.

Precautions

◆Mechanical considerations

Be careful not to subject capacitors to excessive mechanical shocks.

- (1) If ceramic capacitors are dropped onto a floor or a hard surface, they shall not be used.
- (2) Please be careful that the mounted components do not come in contact with or bump against other boards or components.

8. Storage conditions

◆Storage

- 1. To maintain the solderability of terminal electrodes and to keep packaging materials in good condition, care must be taken to control temperature and humidity in the storage area. Humidity should especially be kept as low as possible.
 - Recommended conditions

Precautions

Ambient temperature : Below 30°C
Humidity : Below 70% RH

The ambient temperature must be kept below 40° C. Even under ideal storage conditions, solderability of capacitor is deteriorated as time passes, so capacitors shall be used within 6 months from the time of delivery.

- •Ceramic chip capacitors shall be kept where no chlorine or sulfur exists in the air.
- 2. The capacitance values of high dielectric constant capacitors will gradually decrease with the passage of time, so care shall be taken to design circuits. Even if capacitance value decreases as time passes, it will get back to the initial value by a heat treatment at 150°C for 1hour.

Technical considerations

If capacitors are stored in a high temperature and humidity environment, it might rapidly cause poor solderability due to terminal oxidation and quality loss of taping/packaging materials. For this reason, capacitors shall be used within 6 months from the time of delivery. If exceeding the above period, please check solderability before using the capacitors.

**RCR-2335B(Safety Application Guide for fixed ceramic capacitors for use in electronic equipment) is published by JEITA.

Please check the guide regarding precautions for deflection test, soldering by spot heat, and so on.

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22201ZK00562KXT 1812JZK00332KXT CDR31BX103AKWR CDR33BX104AKUR CDR33BX683AKUS CGA2B2C0G1H010C CGA2B2C0G1H040C CGA2B2C0G1H050C CGA2B2C0G1H060D CGA2B2C0G1H070D CGA2B2C0G1H391J

CGA2B2C0G1H181JT0Y0F CGA2B2C0G1H1R5C CGA2B2C0G1H2R2C CGA2B2C0G1H390J CGA2B2C0G1H391J